TOSHIBA MT6L52AE

TOSHIBA TRANSISTOR SILICON NPN EPITAXIAL PLANAR TYPE

1 T 6 L 5 2 A E

VHF~UHF BAND LOW NOISE AMPLIFIER APPLICATIONS

TWO devices are built in to the super-thin and extreme super

MOUNTED DEVICES

	Q1 : SSM (TESM)	Q2 : SSM (TESM)
Three-pins (SSM/TESM) mold	MT3S03S	MT3S04AS
products are corresponded.	(MT3S03T)	(MT3S04AT)

MAXIMUM RATINGS (Ta = 25°C)

mini (6 pins) package: ES6

CHARACTERISTIC	SYMBOL	Q1	Q2	UNIT
Collector-Base Voltage	V_{CBO}	10	10	V
Collector-Emitter Voltage	v_{CEO}	5	5	V
Emitter-Base Voltage	v_{EBO}	2	2	V
Collector Current	$I_{\mathbf{C}}$	40	40	mA
Base Current	$I_{\mathbf{B}}$	10	10	mA
Collector Power Dissipation	PC (Note 1)	100		mW
Junction Temperature	T_{j}	125		°C
Storage Temperature Range	$ m T_{stg}$	-55~125		°C

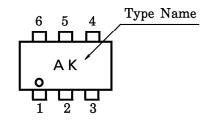
0.5 1.0±0.05 0.5 1.2±0.05 1. COLLECTOR 1 BASE 2 2. EMITTER 1 5. **EMITTER 2 COLLECTOR 2** BASE 1 **JEDEC EIAJ TOSHIBA** 2-2N1C

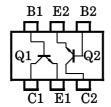
Unit in mm

(Note 1): Total power dissipation of Q1 and Q2.

MARKING

PIN ASSIGNMENT (TOP VIEW)





- TOSHIBA is continually working to improve the quality and the reliability of its products. Nevertheless, semiconductor ■ TOSHIBA is continually working to improve the quality and the reliability of its products. Nevertheless, semiconductor devices in general can malfunction or fail due to their inherent electrical sensitivity and vulnerability to physical stress. It is the responsibility of the buyer, when utilizing TOSHIBA products, to observe standards of safety, and to avoid situations in which a malfunction or failure of a TOSHIBA product could cause loss of human life, bodily injury or damage to property. In developing your designs, please ensure that TOSHIBA products are used within specified operating ranges as set forth in the most recent products specifications. Also, please keep in mind the precautions and conditions set forth in the TOSHIBA Semiconductor Reliability Handbook.
 ● The information contained herein is presented only as a guide for the applications of our products. No responsibility is assumed by TOSHIBA CORPORATION for any infringements of intellectual property or other rights of the third parties which may result from its use. No license is granted by implication or otherwise under any intellectual property or other rights of TOSHIBA CORPORATION or others.
 ● The information contained herein is subject to change without notice.

ELECTRICAL CHARACTERISTICS Q1 (Ta = 25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN	тур	MAX.	UNIT
CITITUTOTEIMSTIC	OTMBOL	I EST CONSTITON	141111.	111.	1417171.	01111
Collector Cut-off Current	I_{CBO}	$V_{CB} = 5 V, I_{E} = 0$	_		0.1	μ A
Emitter Cut-off Current	$I_{ m EBO}$	$V_{EB} = 1 V, I_{C} = 0$	_		1	μ A
DC Current Gain	$h_{ extbf{FE}}$	$ m V_{CE} = 1 V, I_{C} = 5 mA$	80	_	160	_
Transition Frequency	f _T (1)	$V_{CE} = 1 V$, $I_{C} = 5 mA$	3	5	_	GHz
	f _T (2)	$ m V_{CE} = 3~V,~I_{C} = 10~mA$	7	10	_	GHz
Incortion (-ain	$ S_{21e} ^2$ (1)	$ m V_{CE}=1~V,~I_{C}=5~mA,~f=2~GHz$	_	5	_	dB
	$ S_{21e} ^2$ (2)	$V_{CE} = 3 V, I_{C} = 20 \text{ mA}, f = 2 \text{ GHz}$	3	6.5	_	dB
I Noise Kigure	NF (1)	$ m V_{CE}=1~V,~I_{C}=5~mA,~f=2~GHz$	_	1.7	3	dB
	NF (2)	$ m V_{CE}=3~V,~I_{C}=7~mA,~f=2~GHz$	_	1.4	2.2	dB
Reverse Transfer	C	$V_{CB} = 1 V, I_{E} = 0,$		0.8	1.15	рF
Capacitance C _{re}	f = 1 MHz (Note 2)		0.8	1.13	pr	

ELECTRICAL CHARACTERISTICS Q2 (Ta = 25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Collector Cut-off Current	I_{CBO}	$V_{CB} = 5 \text{ V}, I_{E} = 0$	_	_	0.1	μ A
Emitter Cut-off Current	$I_{ m EBO}$	$V_{EB} = 1 V, I_{C} = 0$	_	_	1	μ A
DC Current Gain	$_{ m h_{FE}}$	$V_{CE} = 1 V$, $I_{C} = 5 mA$	80	_	160	_
Transition Frequency	f _T (1)	$V_{CE} = 1 V$, $I_{C} = 5 mA$	2	4.5	_	GHz
	f _T (2)	$V_{ m CE}=3~{ m V},~{ m I}_{ m C}=7~{ m mA}$	5	7	_	GHz
	$ S_{21e} ^2$ (1)	$V_{ ext{CE}} = 1 \text{ V}, \text{ I}_{ ext{C}} = 5 \text{ mA}, \text{ f} = 1 \text{ GHz}$	_	8.5	_	dB
	$ S_{21e} ^2$ (2)	$V_{CE} = 3 \text{ V}, I_{C} = 20 \text{ mA}, f = 1 \text{ GHz}$	7.5	11	_	dB
Noise Figure NF	NF (1)	$V_{ ext{CE}} = 1 \text{ V}, \text{ I}_{ ext{C}} = 5 \text{ mA}, \text{ f} = 1 \text{ GHz}$	_	1.3	2.2	dB
	NF (2)	$ m V_{CE}=3~V,~I_{C}=7~mA,~f=1~GHz$	_	1.2	2	dB
Reverse Transfer Capacitance	$\mathrm{C_{re}}$	$V_{CB} = 1 V, I_{E} = 0,$ f = 1 MHz (Note 2)	_	0.9	1.25	pF

(Note 2): C_{re} is measured by 3 terminal method with capacitance bridge.

HANDLING PRECAUTION

When handling individual devices (which are not yet mounted on a circuit board), be sure that the environment is protected against electrostatic electricity. Operators should wear anti-static clothing, and containers and other objects that come into direct contact with devices should be made of anti-static materials.